

#### 32K-Word By 8 Bit

## CS18LV02563

Rev. 1.2

P 1

#### DESCRIPTION

The CS18LV02563 is a high performance, high speed and super low power CMOS Static Random Access Memory organized as 32,768 words by 8bits and operates from a wide range of 1.8 to 3.6V supply voltage. Advanced CMOS technology and circuit techniques provide both high speed, super low power features and maximum access time of 35/55/70ns in 3.0V operation. Easy memory expansion is provided by an active LOW chip enable (/CE) and active LOW output enable (/OE).

The CS18LV02563 has an automatic power down feature, reducing the power consumption significantly when chip is deselected. The CS18LV02563 is available in JEDEC standard 28-pin TSOP I (8x13.4 mm), SOP (330 mil) and PDIP (600 mil) packages.

#### FEATURES

- Wide operation voltage : 1.8 ~ 3.6V
- Ultra low power consumption : 2mA@1MHz (Max.), Vcc=3.0V.

0.10 uA (Typ.) CMOS standby current

- ➢ High speed access time : 35∼70ns.
- > Automatic power down when chip is deselected.
- > Three state outputs and TTL compatible.
- > Data retention supply voltage as low as 1.5V.
- > Easy expansion with /CE and /OE options.

Part No.	Operating Temp.	Vcc Range	Speed (ns)	Standby Current(Typ.) I <sub>CCSB1</sub>	Package Type
CS18LV02563AC					28 SOP
CS18LV02563BC	0~70°C	1.8~3.6V	35/55/70	0.10 uA	28 TSOP I
CS18LV02563PC				(Vcc = 3.0V)	28 PDIP
CS18LV02563ZC	1				Dice
CS18LV02563AI					28 SOP
CS18LV02563BI	-40~85°C			0.15 uA	28 TSOP I
CS18LV02563PI	-40~85°C		35/55/70	(Vcc= 3.0V)	28 PDIP
CS18LV02563ZI	]				Dice

#### PRODUCT FAMILY

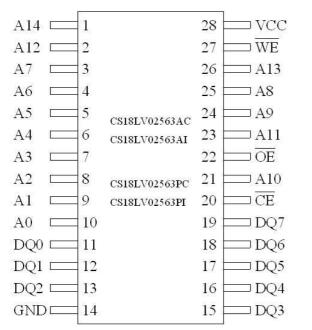
Note: Green package part no, sees order information.



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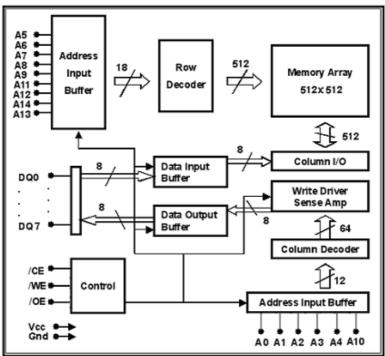
CS18LV02563

#### PIN CONFIGURATIONS



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		)

#### BLOCK DIAGRAM





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Name	Туре	Function
A0 – A14	Input	Address inputs for selecting one of the 32,768 x 8 bit words in the RAM
/CE	Input	/CE is active LOW. Chip enable must be active when data read from or write to the device. If chip enable is not active, the device is deselected and in a standby power mode. The DQ pins will be in high impedance state when the device is deselected.
/WE	Input	The Write enable input is active LOW. It controls read and write operations. With the chip selected, when /WE is HIGH and /OE is LOW, output data will be present on the DQ pins, when /WE is LOW, the data present on the DQ pins will be written into the selected memory location.
/OE	Input	The output enable input is active LOW. If the output enable is active while the chip is selected and the write enable is inactive, data will be present on the DQ pins and they will be enabled. The DQ pins will be in the high impedance state when /OE is inactive.
DQ0~DQ7	I/O	These 8 bi-directional ports are used to read data from or write data into the RAM.
Vcc	Power	Power Supply
Gnd	Power	Ground

#### ■ PIN DESCRIPTIONS

#### ■ TRUTH TABLE

Mode	/WE	/CE	/OE	I/O state	Vcc Current
Not Selected	Х	Н	Х	High Z	$I_{SB}, I_{SB1}$
Output Disabled	Н	L	Н	High Z	I <sub>CC</sub>
Read	Н	L	L	D <sub>OUT</sub>	I <sub>CC</sub>
Write	L	L	Х	D <sub>IN</sub>	I <sub>CC</sub>



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#### ■ ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Parameter	Rating	Unit
V <sub>TERM</sub>	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
T <sub>BIAS</sub>	Temperature Under Bias		°C
T <sub>STG</sub>	Storage Temperature	-60 to +150	°C
PT	P <sub>T</sub> Power Dissipation		W
Ι <sub>ουτ</sub>	l <sub>ouт</sub> DC Output Current		mA

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

#### OPERATING RANGE

Range	Ambient Temperature	Vcc
Commercial	0~70°C	1.8 ~3.6V
Industrial	-40~85°C	1.8 ~ 3.6V

#### ■ CAPACITANCE<sup>(1)</sup>(TA=25°C,f=1.0MHz)

Symbol	Parameter Conduction		MAX.	Unit
C <sub>IN</sub>	Input Capacitance	acitance VIN=0V		pF
C <sub>DQ</sub>	Input/Output Capacitance	VI/O=0V	8	pF

1. This parameter is guaranteed, and not 100% tested.



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#### DC ELECTRICAL CHARACTERISTICS (Over Operating Range) $TYP^{(1)}$ Unit Name Parameter **Test Condition** MIN MAX Guaranteed Input Low V VIL Vcc=1.8V -0.5 0.8 Voltage (2) Guaranteed Input High Vcc+0.2 VIH Vcc=3.6V 2.0 V Voltage (2) I<sub>IL</sub> Input Leakage Current V<sub>CC</sub>=MAX, V<sub>IN</sub>=0 to V<sub>CC</sub> 1 uA V<sub>CC</sub>=MAX, /CE=V<sub>IN</sub>, or I<sub>OL</sub> Output Leakage Current 1 uA $OE=V_{IN}$ , $V_{IO}=0V$ to $V_{CC}$ VOL Output Low Voltage $V_{CC}$ =MAX, $I_{OL}$ = 1mA 0.4 ν ν V<sub>OH</sub> Output High Voltage V<sub>CC</sub>=MIN, I<sub>OH</sub>=-0.5mA 1.6 Operating Power Supply /CE=V<sub>IL</sub>, I<sub>DQ</sub>=0mA, 20 mA lcc $F=F_{MAX}=1/t_{RC}$ Current TTL Standby Supply 1 **I**<sub>CCSB</sub> /CE=V<sub>IH</sub>, I<sub>DQ</sub>=0mA, mA $/CE \ge V_{CC}$ -0.2V, $V_{IN} \ge$ CMOS Standby Current 0.1 2 uA $V_{CC}$ -0.2V or $V_{IN} \le 0.2V$ ,

**1.** Typical characteristics are at TA =  $25^{\circ}$ C.

2. These are absolute values with respect to device ground and all overshoots due to system or tester notice are included.

#### ■ DATA RETENTION CHARACTERISTICS (Over Operating Range)

Name	Parameter	Test Condition	MIN	TYP <sup>(1)</sup>	MAX	Unit
V <sub>DR</sub>	V <sub>CC</sub> for Data Retention	/CE $\geq$ V <sub>CC</sub> -0.2V, V <sub>IN</sub> $\geq$	1.5			V
V DR		$V_{CC}\text{-}0.2V$ or $V_{IN}{\leq}0.2V$	1.5			v
	Data Retention Current	/CE $\geq$ V <sub>CC</sub> -0.2V, V <sub>IN</sub> $\geq$		0.1	0.8	uA
ICCDR		$V_{CC}\text{-}0.2V$ or $V_{IN}{\leq}0.2V$		0.1	0.0	uA
т	Chip Deselect to Data	Refer to	0			20
$T_{CDR}$	Retention Time	Retention Waveform	0			ns
t <sub>R</sub>	Operation Recovery Time		t <sub>RC</sub> (2)			ns

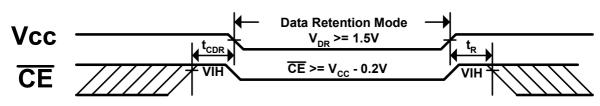
1. TA = 25°C.

2.  $t_{\text{RC}=.}$  Read Cycle Time.



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#### ■ LOW Vcc DATA RETENTION WAVEFORM ( /CE Controlled



AC TEST CONDI	TIONS
Input Pulse Levels	Vcc/0V
Input Rise and Fall Times	5ns
Input and Output Timing Reference Level	0.5Vcc

#### **KEY TO SWITCHING WAVEFORMS**

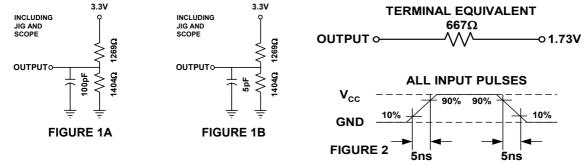
WAVEFORMS	INPUTS	OUTPUTS		
	MUST BE STEADY	MUST BE STEADY		
	MAY CHANGE FROM H TO L	WILL BE CHANGE FROM H TO L		
	MAY CHANGE FROM L TO H	WILL BE CHANGE FROM L TO H		
	DON'T CARE ANY CHANGE PERMITTED	CHANGE STATE UNKNOWN		
	DOES NOT APPLY	CENTER LINE IS HIGH IMPEDANCE OFF STATE		



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#### AC TEST LOADS AND WAVEFORMS



# AC ELECTRICAL CHARACTERISTICS (Over Operating Range) < READ CYCLE >

JEDEC	Symbol	Description	-3	35	-5	55	-7	<b>'</b> 0	Unit
Name	Symbol	Description	MIN	MAX	MIN	MAX	MIN	MAX	Unit
t <sub>AVAX</sub>	t <sub>RC</sub>	Read Cycle Time	35		55		70		ns
t <sub>AVQV</sub>	t <sub>AA</sub>	Address Access Time		35		55		70	ns
t <sub>ELQV</sub>	t <sub>CE</sub>	Chip Select Access Time		35		55		70	ns
t <sub>GLQV</sub>	t <sub>OE</sub>	Output Enable to Output		20		30		50	ns
		Valid							
t <sub>ELQX</sub>	t <sub>cLZ</sub>	Chip Select to Output Low Z	10		10		10		ns
t <sub>GLQX</sub>	t <sub>oLZ</sub>	Output Enable to Output in	5		5		5		ns
		Low Z							
t <sub>EHQZ</sub>	t <sub>CHZ</sub>	Chip Deselect to Output in	0	35	0	35	0	35	ns
		High Z							
t <sub>GHQZ</sub>	t <sub>онz</sub>	Output Disable to Output in	0	20	0	30	0	30	ns
		High Z							
t <sub>AXOX</sub>	t <sub>он</sub>	Address Change to Out	10		10		10		ns
		Disable							

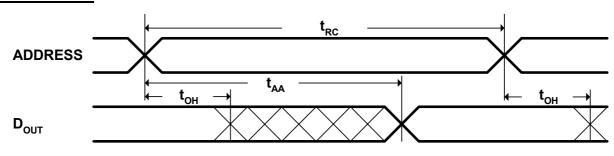


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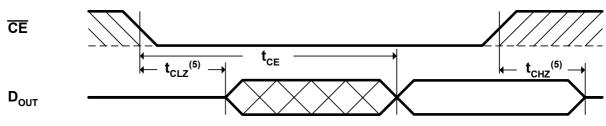
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#### ■ SWITCHING WAVEFORMS (READ CYCLE)

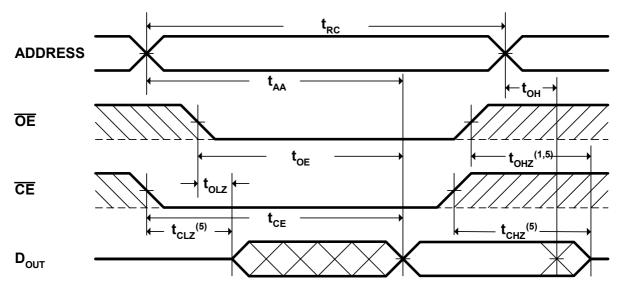
**READ CYCLE1** (1,2,4)



READ CYCLE2 (1,3,4)



READ CYCLE3 (1,4)





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#### NOTES:

- 1. /WE is high in read Cycle.
- 2. Device is continuously selected when /CE =  $V_{IL}$ .
- 3. Address valid prior to or coincident with CE transition low.
- 4. /OE = VIL.
- 5. Test conditions assume signal transition times of 5ns or less, timing reference levels of 0.5VCC, input pulse levels of 0V to VCC and output loading specified in Figure 1A.
- 6. Transition is measured  $\pm$ 500mV from steady state with C<sub>L</sub> = 5pF as shown in Figure 1B. The parameter is guaranteed but not 100% tested.

## AC ELECTRICAL CHARACTERISTICS (Over Operating Range) < WRITE CYCLE >

JEDEC	Symbol	Description	-3	35	-5	55	-70		Unit
Name	Symbol	Description	MIN	MAX	MIN	MAX	MIN	MAX	Unit
t <sub>AVAX</sub>	t <sub>wc</sub>	Write Cycle Time	35		55		70		ns
t <sub>E1LWH</sub>	t <sub>cw</sub>	Chip Select to End of Write	35		55		70		ns
t <sub>AVWL</sub>	t <sub>AS</sub>	Address Setup Time	0		0		0		ns
t <sub>AVWH</sub>	t <sub>AW</sub>	Address Valid to End of Write	35		55		70		ns
t <sub>w∟wн</sub>	t <sub>wP</sub>	Write Pulse Width	25		40		50		ns
t <sub>whax</sub>	t <sub>wR</sub>	Write Recovery Time	0		0		0		ns
t <sub>wLQZ</sub>	t <sub>wHZ</sub>	Write to Output in High Z		20		25		35	ns
t <sub>DVWH</sub>	t <sub>DW</sub>	Data to Write Time Overlap	15		20		30		ns
t <sub>whdx</sub>	t <sub>DH</sub>	Data Hold for Write End			0		0		ns
t <sub>GHQZ</sub>	t <sub>онz</sub>	Output Disable to Output in		20	0	30	0	30	ns
		High Z							
t <sub>wнох</sub>	t <sub>ow</sub>	End of Write to Output Active	5		5		5		ns

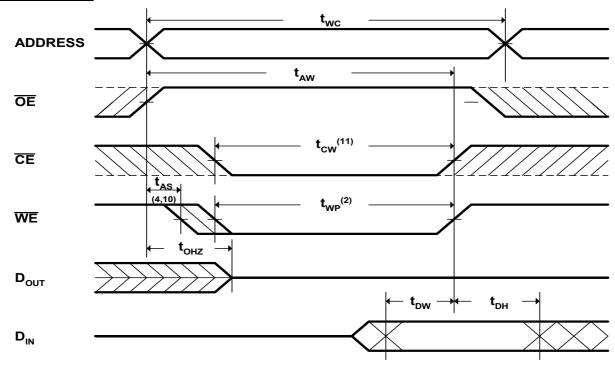


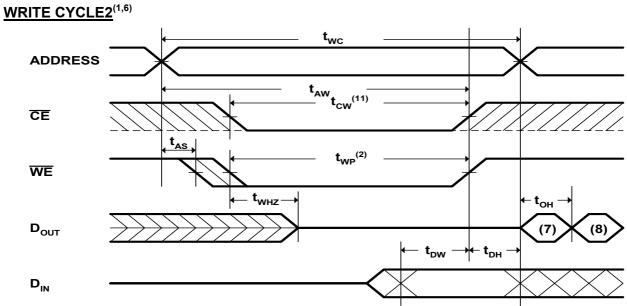
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#### SWITCHING WAVEFORMS (WRITE CYCLE)

WRITECYCLE1<sup>(1)</sup>







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#### NOTES:

- 1. /WE must be high during address transitions.
- 2. The internal write time of the memory is defined by the overlap of /CE and /WE low. All signals must be active to initiate a write and any one signal can terminate a write by going inactive. The data input setup and hold timing should be referenced to the second transition edge of the signal that terminates the write.
- 3. T<sub>WR</sub> is measured from the earlier of /CE or /WE going high at the end of write cycle.
- 4. During this period, DQ pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
- 5. If the /CE low transition occurs simultaneously with the /WE low transitions or after the /WE transition, output remain in a high impedance state.
- 6. /OE is continuously low (/OE =  $V_{IL}$ ).D<sub>OUT</sub> is the same phase of write data of this write cycle.
- 8.  $D_{OUT}$  is the read data of next address.
- 9. If /CE is low during this period, DQ pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.
- 10. Test conditions assume signal transition times of 5ns or less, timing reference levels of 0.5VCC, input pulse levels of 0V to VCC and output loading specified in Figure 1A.
- Transition is measured ±500mV from steady state with C<sub>L</sub> = 5pF as shown in Figure 1B. The parameter is guaranteed but not 100% tested.
- 12.  $T_{CW}$  is measured from the later of /CE going low to the end of write.



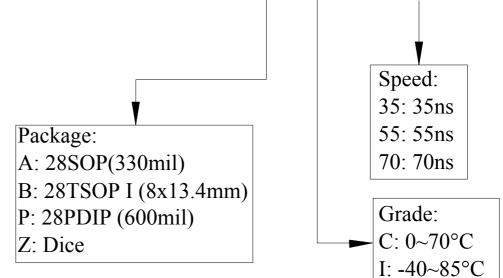
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#### ORDER INFORMATION

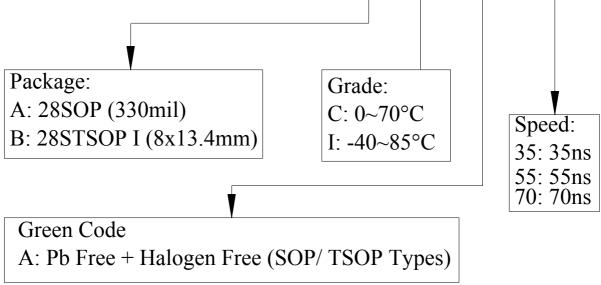
#### 1. NON-GREEN PACKAGE:

# CS18LV02563 F M - HH



#### 2. GREEN PACKAGE:

# $CS18LV02563 \xrightarrow{X} \xrightarrow{X} \xrightarrow{X} \xrightarrow{XX}$

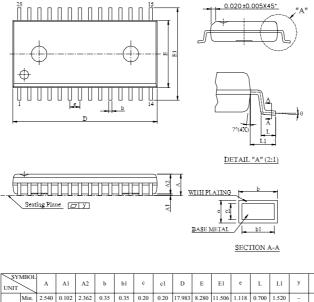




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#### PACKAGE DIMENSIONS

- 28 pin SOP (330 mil) :



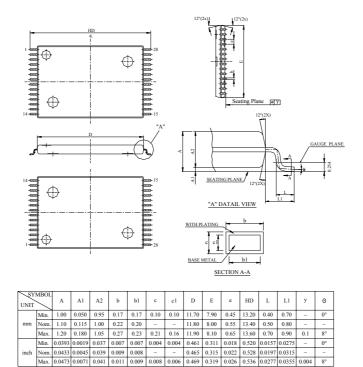
SYMBOL		А	Al	A2	b	bl	с	cl	D	Е	E1	e	L	Ll	у	Θ
mm	Min.	2.540	0.102	2.362	0.35	0.35	0.20	0.20	17.983	8.280	11.506	1.118	0.700	1.520	-	0°
	Nom.	2.692	0.226	2.489	-	-	-	-	18.110	8.407	11.811	1.270	0.964	1.720	-	-
	Max.	2.844	0.350	2.616	0.50	0.45	0.32	0.28	18.237	8.534	12.116	1.422	1.228	1.920	0.1	10°
	Min.	0.100	0.004	0.093	0.014	0.014	0.008	0.008	0.708	0.326	0.453	0.044	0.0276	0.0598	-	0°
inch	Nom.	0.106	0.009	0.098	-	-	-	-	0.713	0.331	0.465	0.050	0.0380	0.0677	-	-
	Max.	0.112	0.014	0.103	0.020	0.018	0.012	0.011	0.718	0.336	0.477	0.056	0.0484	0.0756	0.004	10°



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28 pin TSOP I (8x13.4 mm) : \_

inch

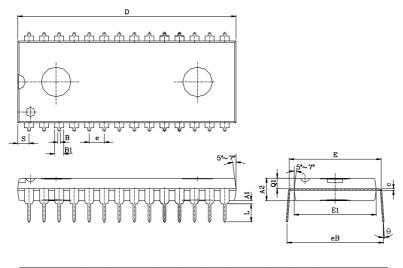


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- 28 pin PDIP (600mil):



SYMBOL															
UNIT		A1	A2	В	B1	с	D	E	E1	e	eB	L	S	Q1	Θ
	Min.	0.254	3.683	0.330	1.270	0.152	36.957	14.986	13.716	2 540	15.748	3.048	1.778	1.651	3°
mm	Nom.	-	3.810	0.457	1.524	0.254	37.084	15.240	13.818		16.256	3.302	2.032	1.778	6°
	Max.	-	3.937	0.584	1.778	0.356	37.211	15.494	13.920		16.764	3.556	2.286	1.905	9°
	Min.	0.010	0.145	0.013	0.050	0.006	1.455	0.590	0.540	0.100 (TYP)	0.620	0.120	0.070	0.065	3°
inch	Nom.	-	0.150	0.018	0.060	0.010	1.460	0.600	0.544		0.640	0.130	0.080	0.070	6°
	Max.	-	0.155	0.023	0.070	0.014	1.465	0.610	0.548		0.660	0.140	0.090	0.075	9°